

FEE TRANSMITTAL

Electronic Version v08

Stylesheet Version v08.0

**Title of
Invention**

ALL-IN-ONE POLISHING PROCESS FOR A SEMICONDUCTOR WAFER

Application Number :

Date :

First Named Applicant: Mu-Liang Liao

Attorney Docket Number: NAUP0511USA

TOTAL FEE AUTHORIZED \$ 882

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

BASIC FILING FEE

Fee Description	Fee Code	Amount \$	Fee Paid \$
Utility Filing Fee	1001	770	770
Subtotal For Basic Filing Fees: \$ 770			

EXTRA CLAIM FEES

Fee Description	Extra Claim	Fee Code	Amount \$	Fee Paid \$
Total Claims : 24	4	1202	18	72
Independent Claims : 3	0	1201	86	0
Subtotal For Extra Claims Fees: \$ 72				

ASSIGNMENT FEES

Fee Description	Property Number	Quantity	Fee Code	Amount \$	Fee Paid \$
Recording Each Patent Assignment Per Property Fee	00000000	1	8021	40	40
Subtotal For Additional Fees: \$40					

AUTHORIZED BILLING INFORMATION**The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:**

Deposit account number: 500801

Access Code *****

Deposit name: NORTH AMERICA INTERNATIONAL PATENT OFFICE

Deposit authorized name: WINSTON HSU

Signature: VAEB-JMXX-8IIL

Date (YYYYMMDD): 2004-01-15

Charge Assignment Fees Required Under 37 C.F.R. Section 1.21 (h).

Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.